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| <br><b>Greenconn Technology (GanZhou) Ltd.</b> |                                     | 文件編號    | PS-N07-0005      |
|                                                                                                                                 |                                     | 版次      | B/3              |
| 類別                                                                                                                              | GPB SERIES PRODUCT<br>SPECIFICATION | 頁次      | 1 / 7            |
| PS                                                                                                                              |                                     | 制 定 部 門 | 研發單位             |
|                                                                                                                                 |                                     | 公 佈 日 期 | 2025 年 12 月 24 日 |

| 文件變更履歷表 |                                             |     |            |     |             |
|---------|---------------------------------------------|-----|------------|-----|-------------|
| 版次      | 制 / 修 / 廢原因                                 |     |            | 頁次  | 制 / 修 / 廢日期 |
| B/2     | 產品規範改用中英文格式,PIN 保持力改為 1N/Pin                |     |            | A   | 2017/11/27  |
| B/3     | 更正 4.1.2 Voltage Rating (額定電壓) : 50V AC/DC. |     |            | 全部  | 2025/12/24  |
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| 核       | 邱國延                                         | 審 查 | 張春進        | 制 定 | 何東華         |
| 日 期     | 2025/12/24                                  | 日 期 | 2025/12/24 | 日 期 | 2025/12/24  |

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## 1.0 SCOPE（范围）：

This specification covers the requirements for product performance and test methods of the GPB Series connector. Product shall be of the design, construction and physical dimensions specified in the applicable product drawing.（本規格書涵蓋了GPB Series連接器的產品性能要求和測試方法。產品應符合適用產品圖面中規定的設計、結構、尺寸等。）

## 2.0 APPLICABLE DOCUMENTS（適用文件）：

The following document, of the latest issue in effect at the time of performance of the qualification tests, shall form a part of this specification to the extent specified herewith.（本版本中以下文件，在性能鑒定試驗時生效，將構成本規範的一部分。）

EIA-364 Test methods for electrical connectors.（EIA-364 電器連接器的測試方法）

## 3.0 PRODUCT DESCRIPTION AND PART NUMBER（產品描述和型號）：

| Product description（產品描述）   | Part No.（型號） |
|-----------------------------|--------------|
| PITCH 0.80mm MALE CONNECTOR | GPB SERIES   |

## 4.0 PROPERTY（特性）：

### 4.1 Ratings（額定值）：

4.1.1 Current Rating（額定電流）：0.5A (AC / DC) Per contact.

4.1.2 Voltage Rating（額定電壓）：50V AC/DC.

4.1.3 Operating Temperature Range（工作溫度）：-40℃~105℃.

4.1.4 Operating Humidity（工作濕度）：85% Max.

### 4.2 Materials（材料）：

4.2.1 Housing（塑殼）：LCP, Nylon 6T, PBT, Nylon 9T, Nylon 66 or Nylon 46, flame retardant 94V-0 per UL-94; or other high performance resin.

4.2.2 Contact（端子）：Brass, Phosphor Bronze or other equivalent copper alloys.

Finish（表面處理）：See plating drawing.

4.2.3 Harmful Material Should Be Compliant to GREENCONN Standards (Per QPNQ0817).

有害物質應 符合格菱公司的標準(參考文件QPNQ0817)。

## 5.0 TEST CONDITION（測試條件）：

5.1 Temperature range（溫度範圍）：20℃ to 30℃.

5.2 Humidity range（濕度範圍）：30% RH to 70%RH.

## 6.0 STORAGE CONDITION（儲藏條件）：

6.1 Temperature range（溫度範圍）：5℃~30℃.

6.2 Humidity range（濕度條件）：≤65%.

6.3 Shelf life（存儲期限）：1 Year.

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## 7.0 TEST METHODS AND REQUIREMENTS（測試方法和要求）：

### 7.1 GENERAL EXAM（一般測試）：

| Test item<br>（測試項目） |                                     | Test procedure<br>（測試流程）                                                 | Condition of<br>test specimens<br>（測試狀態） | Requirement<br>（要求）                                                                |
|---------------------|-------------------------------------|--------------------------------------------------------------------------|------------------------------------------|------------------------------------------------------------------------------------|
| 1                   | Examination of<br>Product<br>（產品檢查） | Per EIA-364-18 Visual and functional inspection.（依照 EIA-364-18 外觀和功能性檢查） |                                          | Meet requirements of product drawing. No evidence of physical damage（符合圖面要求,無物理損傷） |

### 7.2 ELECTRICAL PERFORMANCE（電氣性能）：

| Test item<br>（測試項目） |                                                    | Test procedure<br>（測試流程）                                                                                                                                   | Condition of test<br>specimens（測試<br>狀態） | Requirement<br>（要求）                                                   |
|---------------------|----------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------|-----------------------------------------------------------------------|
| 1                   | Low level<br>contact<br>resistance<br>（低階接觸阻<br>抗） | Per EIA-364-23 Subject mated connector with a max. voltage of 20mV and current of 100mA. (依照EIA-364-23 在配對連接器上施加最大20mV電壓和100mA電流。)                         | Mating<br>（配對）                           | Initial = 20mΩ Max.<br>Final = 30mΩ Max.                              |
| 2                   | Dielectric<br>Withstanding<br>Voltage<br>（耐电压）     | Per EIA-364-20 Subject mated connector with a. voltage of 200V AC for 1 minute between adjacent terminals.（依照EIA-364-20 在配對好的連接器的相鄰兩個端子上接通200V的交流電，持續1分鐘。） | Mating<br>（配對）                           | No Breakdown.<br>Leakage Current:<br>5mA Max.（無擊<br>穿，漏電電流：5mA<br>最大） |
| 3                   | Insulation<br>Resistance<br>（絕緣阻抗）                 | Per EIA-364-21 Subject mated connector with a. voltage of 500V DC between adjacent terminals.（依照 EIA-364-21，在配對好的連接器的相鄰兩個端子上接通 500V 的直流電。）                 |                                          | 500MΩ Min.                                                            |

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### 7.3 MECHANICAL PERFORMANCE (機械性能測試) :

| Test item<br>(測試項目) |                                        | Test procedure<br>(測試流程)                                                                                                                                                           | Condition of test<br>specimens (測試<br>狀態) | Requirement<br>(要求)                          |
|---------------------|----------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------|----------------------------------------------|
| 1                   | Contact<br>Retention<br>Force<br>(保持力) | Per EIA-364-37 The end of a post shall be pulled in a perpendicular to base housing at a constant speed of 25.4mm/ minute. (依照 EIA-364-37, 垂直與基殼方向上以 25.4mm/ minute 恒定的測試速度拉端子末端。) |                                           | 1.00N Min. per pin.                          |
| 2                   | Durability<br>(耐久度)                    | Per EIA-364-09 Perform 100 cycle Mating/ un-mating at a rate of 25.4mm/ minute. (依照 EIA-364-09以25.4mm/ minute勻速速度循環插拔100次。)                                                        |                                           | No evidence of<br>physical damage<br>無物理損傷現象 |

### 7.4 ENVIRONMENTAL PERFORMANCE (環境性能) :

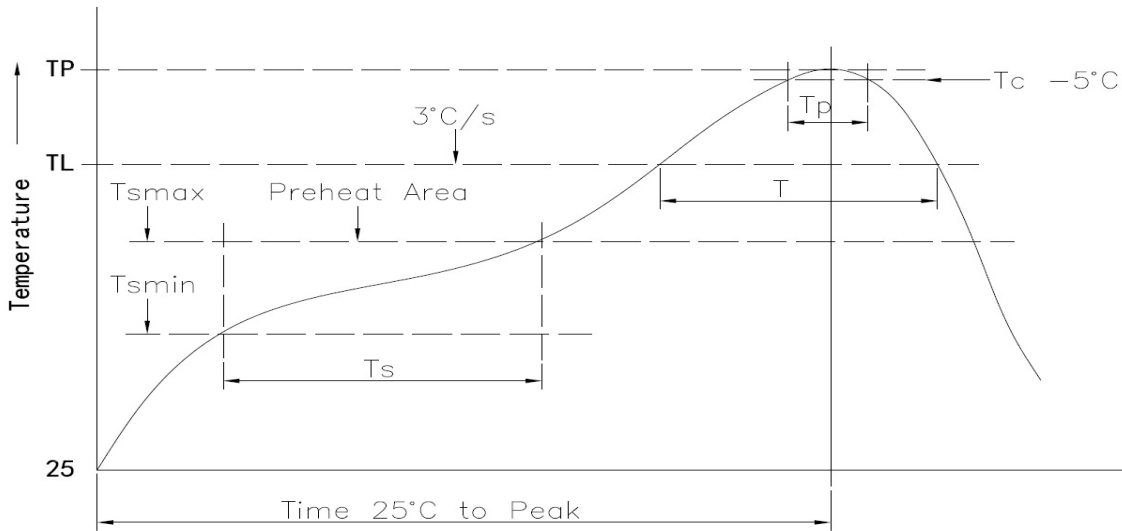
| Test item<br>(測試項目) |                                 | Test procedure<br>(測試流程)                                                                                                                                                                                                                                                                                                                                                        | Condition of test<br>specimens (測試<br>狀態) | Requirement<br>(要求)                          |
|---------------------|---------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------|----------------------------------------------|
| 1                   | Thermal Shock<br>(冷熱衝擊)         | Per EIA-364-32, Mated connectors: expose to 5cycles of: (依照EIA-364-32,執行如下條件的5次循環)<br><div> <div>Temperature°C</div> <div>溫度</div> </div> <div> <div>Duration(Minutes)</div> <div>持續時間(分)</div> </div> <div>-40°C +0/-5</div> <div>30 Min.</div> <div>+25°C +10/-5</div> <div>5 Max.</div> <div>+105°C +3/-0</div> <div>30 Min.</div> <div>+25°C +10/-5</div> <div>5 Max.</div> |                                           | No evidence of<br>physical damage<br>無物理損傷現象 |
| 2                   | Temperature<br>life(高溫壽命<br>測試) | Per EIA-364-17 Test Condition: 105°C, 96hours. (依照EIA-364-17,測試條件: 105°C, 96小時。)                                                                                                                                                                                                                                                                                                |                                           | No evidence of<br>physical damage<br>無物理損傷現象 |
| 3                   | Humidity<br>Test(濕度測<br>試)      | Per EIA-364-31 Test Condition: 40±2°C, 90-95% RH, 96 hrs.<br>(依照 EIA-364-31, 測試條件: 40±2°C, 90-95% RH,96 小時。)                                                                                                                                                                                                                                                                    |                                           | No evidence of<br>physical damage<br>無物理損傷現象 |

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| 4 | Salt Spray<br>(鹽霧)                         | Per EIA-364-26 Test Condition:<br>Temperature: 35±2°C;<br>Atmosphere: 5% salt-solution.<br>Duration:<br>16 Hours exposure for gold area;<br>8 Hours exposure for tin area.<br><br>(依照 EIA-364-26 測試條件：35±2°C，錫區域: 8 小時；金區域：16 小時, 5% 鹽溶液.)                                                                                                                                                                                                                   |  | No evidence of<br>physical damage<br><br>無物理損傷現象                                                                                 |
| 5 | Solder ability<br>Test<br>(可焊性測試)          | Per EIA-364-71 Test Temperature: 245±3°C,<br>3~5sec.<br>(依照EIA-364-71 測試溫度：245±3°C,<br>3~5秒)                                                                                                                                                                                                                                                                                                                                                                 |  | After exposure, the<br>contact solder tails<br>shall have a<br>minimum of 95%<br>solder coverage.<br>(風乾後，端子焊<br>錫覆蓋率至少<br>95%。) |
| 6 | Resistance to<br>Soldering Heat<br>(焊接耐熱性) | Per EIA-364-56<br>Soldering iron method<br>Solder Temp.: 380±10°C/3~5 seconds.<br><br>Reflow (Only suitable for the materials<br>with high temperature resistance.):<br>Please see recommended profile.<br>Pre Heat: 150°C~200°C/60 to 120 seconds<br>Heat: 217 °C;60-150 seconds<br>Peak Temp.: 260±5°C/5~15 seconds.<br>(依照EIA-364-56，手工焊接溫度：380±<br>10°C/3~5秒，回流焊(適用於耐高溫材<br>料)：預加熱：150°C~200°C /60-120 秒;加熱：<br>217 °C;60-150 秒；最高溫度：260±5°C<br>/5~15 秒) |  | No evidence of<br>physical damage<br><br>無物理損傷現象                                                                                 |

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### 8.0 INFRARED REFLOW CONDITION (LEAD-FREE)(回流焊條件(無鉛)):



| Profile Feature (特性)                                                                    | Lead-Free Assembly (無鉛組裝)     |
|-----------------------------------------------------------------------------------------|-------------------------------|
| Preheat & Soak (預熱&浸泡)<br>Temperature min (最低溫度)<br>Temperature max (最高溫度)<br>Time (時間) | 150°C~200°C/60 to 120 seconds |
| Average ramp-up rate<br>(平均溫升率)                                                         | 3 °C/second max.              |
| Liquids temperature (TL) (液化溫度)<br>Time at liquids (液化時間)                               | 217 °C<br>60-150 seconds      |
| Peak package body temperature<br>(封裝最高溫度)                                               | 260±5°C/5~15 seconds          |
| Time within 5 °C of the specified classification temperature (Tc)<br>(在指定等級溫度5°C內的時間)   | 20~40seconds                  |
| Average ramp-down rate<br>(平均溫度下降速率)                                                    | 6 °C/second max.              |
| Time 25 °C to peak temperature<br>(25 °C至峰值溫度的時間)                                       | 8 minutes max.                |

(a) Per IPC/JEDECJ-SID-020 Clause 5.6. (依照 IPC/JEDECJ-SID-020 中 5.6 小節.)

(b) Test Condition: Test connector shall be placed on the p.c. board.

(測試條件：須在 PCB 板上測試連接器。)

(c) Temperature condition graph: Temperature on board pattern side.

(溫度條件曲線圖：在板子圖案面的溫度。)

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(d) Thickness of steel mesh: 0.12mm Min. (鋼網厚度：最小 0.12mm.)

(e) Lead-free Process: DURATION = 2 TIMES. (無鉛製程：持續=2 回。)

## 9.0 PRODUCT QUALIFICATION AND TEST SEQUENCE (產品認證和測試序列)：

| Test Item                             | A   | B   | C   | D   | E   | F | G   | H   |
|---------------------------------------|-----|-----|-----|-----|-----|---|-----|-----|
| Sample Size                           | 3   | 3   | 3   | 3   | 5   | 3 | 3   | 3   |
| Examination of Product (產品檢查)         | 1,5 | 1,5 | 1,9 | 1,7 | 1,5 | 1 | 1,3 | 1,3 |
| Low level contact resistance (低階接觸阻抗) | 2,4 | 2,4 | 2,8 |     | 2,4 |   |     |     |
| Insulation Resistance (絕緣阻抗)          |     |     | 3,7 | 2,5 |     |   |     |     |
| Dielectric Withstanding Voltage (耐電壓) |     |     | 4,6 | 3,6 |     |   |     |     |
| Temperature Life (高溫壽命)               |     | 3   |     |     |     |   |     |     |
| Humidity Test (溫度測試)                  |     |     |     | 4   |     |   |     |     |
| Thermal shock (冷熱衝擊)                  | 3   |     |     |     |     |   |     |     |
| Solder ability (可焊性)                  |     |     |     |     |     |   |     | 2   |
| Resistance to Soldering Heat (焊接耐熱性)  |     |     |     |     |     |   | 2   |     |
| Contact Retention Force (保持力)         |     |     |     |     |     | 2 |     |     |
| Durability (耐久)                       |     |     |     |     | 3   |   |     |     |
| Salt Spray (鹽霧)                       |     |     | 5   |     |     |   |     |     |